# imall

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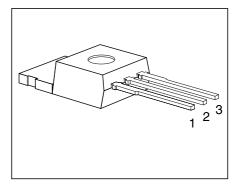
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#### Features

- N channel
- Logic level
- Enhancement mode
- Temperature sensor with thyristor characteristic
  The drain pin is electrically shorted to the tab



Pin	1	2	3
	G	D	S

Туре	$V_{ t DS}$	ID	R <sub>DS(on)</sub>	Package	Ordering Code
BTS 115A	50 V	15.5 A	0.12 Ω	TO-220AB	C67078-S5004-A2

#### **Maximum Ratings**

Parameter	Symbol	Values	Unit
Drain-source voltage	V <sub>DS</sub>	50	V
Drain-gate voltage, $R_{\rm GS}$ = 20 k $\Omega$	$V_{\rm DGR}$	50	
Gate-source voltage	V <sub>GS</sub>	± 10	
Continuous drain current, $T_{\rm C}$ = 25 °C	ID	15.5	Α
ISO drain current $T_{\rm C}$ = 85 °C, $V_{\rm GS}$ = 4.5 V, $V_{\rm DS}$ = 0.5 V	I <sub>D-ISO</sub>	3.2	
Pulsed drain current, $T_{\rm C} = 25 ^{\circ}{\rm C}$	I <sub>D puls</sub>	62	
Short circuit current, $T_j = -55 \dots + 150 \text{ °C}$	I <sub>SC</sub>	37	
Short circuit dissipation, $T_j = -55 \dots + 150 \text{ °C}$	P <sub>SCmax</sub>	550	W
Power dissipation	P <sub>tot</sub>	50	
Operating and storage temperature range	$T_{\rm j}, T_{\rm stg}$	- 55 + 150	°C
DIN humidity category, DIN 40 040	-	E	-
IEC climatic category, DIN IEC 68-1	-	55/150/56	
Thermal resistance			K/W
Chip-case	$R_{ m th \ JC}$	≤ 2.5	
Chip-ambient	$R_{ m th JA}$	≤ 75	



#### **Electrical Characteristics**

at  $T_{\rm j}$  = 25 °C, unless otherwise specified.

Parameter	Symbol		Values		Unit
		min.	typ.	max.	

#### **Static Characteristics**

Drain-source breakdow $V_{GS} = 0, I_D = 0.25 \text{ mA}$	vn voltage	$V_{(BR)DSS}$	50	_	_	V
Gate threshold voltage $V_{GS} = V_{DS}$ , $I_D = 1.0 \text{ mA}$		V <sub>GS(th)</sub>	1.5	2.0	2.5	
$\frac{1}{2}$ Zero gate voltage drait $V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}$		I <sub>DSS</sub>				μA
, <sub>GS</sub> = 0 0, <sub>1</sub> <sub>DS</sub> = 00 0	$T_{\rm j}$ = 25 °C $T_{\rm i}$ = 125 °C		-	0.1 10	1.0 100	
Gate-source leakage of $V_{GS} = 20 \text{ V}, V_{DS} = 0$	current	I <sub>GSS</sub>				
	$T_{\rm j}$ = 25 °C $T_{\rm j}$ = 150 °C		-  -	10 2	100 4	nA μA
Drain-source on-state $V_{\rm GS}$ = 4.5 V, $I_{\rm D}$ = 7.8 A		R <sub>DS(on)</sub>	_	0.09	0.12	Ω

#### **Dynamic Characteristics**

Forward transconductance	g <sub>fs</sub>				S
$V_{\rm DS} \ge 2 \times I_{\rm D} \times R_{\rm DS(on)max}$ , $I_{\rm D}$ =7.8 A		5.5	9.5	_	
Input capacitance $V_{GS}$ = 0, $V_{DS}$ = 25 V, $f$ = 1 MHz	$C_{\rm iss}$	_	550	735	pF
Output capacitance $V_{GS} = 0, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{\rm oss}$	_	220	320	
Reverse transfer capacitance $V_{GS} = 0$ , $V_{DS} = 25$ V, $f = 1$ MHz	$C_{\rm rss}$	_	85	150	
Turn-on time $t_{on}$ , $(t_{on} = t_{d(on)} + t_r)$	t <sub>d(on)</sub>	_	15	25	ns
$V_{\rm CC} = 30 \text{ V}, V_{\rm GS} = 5 \text{ V}, I_{\rm D} = 3 \text{ A}, R_{\rm GS} = 50 \Omega$	<i>t</i> <sub>r</sub>	_	70	100	
Turn-off time $t_{off}$ , $(t_{off} = t_{d(off)} + t_{f})$	t <sub>d(off)</sub>	_	70	90	
$V_{\rm CC}$ = 30 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 3 A, $R_{\rm GS}$ = 50 $\Omega$	t <sub>f</sub>	_	50	70	





#### Electrical Characteristics (cont'd)

at  $T_i = 25 \degree C$ , unless otherwise specified.

Parameter	Symbol		Values		Unit
		min.	typ.	max.	

#### **Reverse Diode**

Continuous source current	Is	_	_	15.5	A
Pulsed source current	I <sub>SM</sub>	_	_	62	
Diode forward on-voltage $I_{\rm F}$ = 34 A, $V_{\rm GS}$ = 0	$V_{ m SD}$	_	1.5	1.8	V
Reverse recovery time $I_{\rm F} = I_{\rm S}$ , d $i_{\rm F}$ /d $t$ = 100 A/µs, $V_{\rm R}$ = 30 V	t <sub>rr</sub>	_	60	_	ns
Reverse recovery charge $I_{\rm F} = I_{\rm S},  {\rm d}i_{\rm F}/{\rm d}t = 100  {\rm A}/{\rm \mu s},  V_{\rm B} = 30  {\rm V}$	Q <sub>rr</sub>	_	0.10	_	μC

#### **Temperature Sensor**

Forward voltage	$V_{\rm TS(on)}$				V
$I_{\text{TS(on)}} = 5.0 \text{ mA}, T_{\text{j}} = -55 \dots + 150 \text{ °C}$			1.3	1.4	
Sensor override, $t_p \le 100 \ \mu s$ $T_j = -55 \ + 160 \ ^{\circ}C$		_	_	10	
Forward current	$I_{\mathrm{TS(on)}}$				mA
$T_{\rm j} = -55 \dots + 150 ^{\circ}{\rm C}$		-	-	5	
Sensor override, $t_p \le 100 \ \mu s$					
$T_{\rm j} = -55 \dots + 160 ^{\circ}{\rm C}$		-	—	600	
Holding current, $V_{TS(off)} = 5 \text{ V},  T_i = 25 \text{ °C}$	I <sub>H</sub>	0.05	0.1	0.5	
$T_{\rm j}$ = 150 °C		0.05	0.2	0.3	
Switching temperature	$T_{\rm TS(on)}$				°C
$V_{\text{TS}} = 5 \text{ V}$		150	-	-	
Turn-off time	t <sub>off</sub>				μs
$V_{\text{TS}}$ = 5 V, $I_{\text{TS(on)}}$ = 2 mA		0.5	-	2.5	



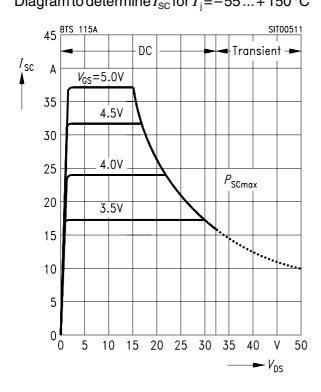
#### **Examples for short-circuit protection**

at  $T_i = -55 \dots + 150 \circ C$ , unless otherwise specified.

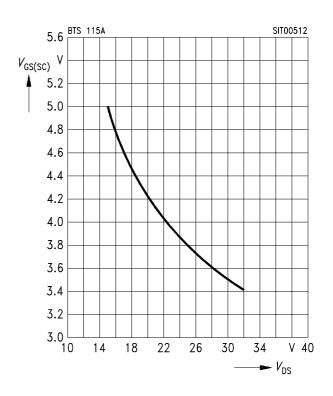
Parameter	Symbol	Examples			Unit
		1	2	_	
Drain-source voltage	$V_{\sf DS}$	15	30	-	V
Gate-source voltage	V <sub>GS</sub>	5.0	3.5	_	
Short-circuit current	I <sub>SC</sub>	37	17	_	A
Short-circuit dissipation	P <sub>SC</sub>	550	510	_	W
Response time $T_{\rm j}$ = 25 °C, before short circuit	t <sub>SC(off)</sub>	25	25	_	ms

## Short-circuit protection $I_{SC} = f(V_{DS})$

Parameter:  $V_{GS}$ Diagram to determine  $I_{SC}$  for  $T_i = -55... + 150 °C$ 

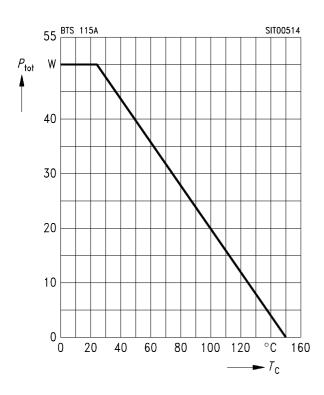


Max. gate voltage  $V_{GS(SC)} = f(V_{DS})$ Parameter:  $T_i = -55 \dots + 150 \text{ °C}$ 

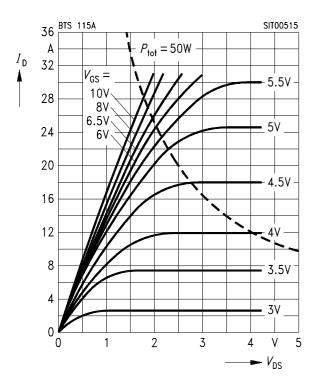




Max. power dissipation  $P_{tot} = f(T_c)$ 

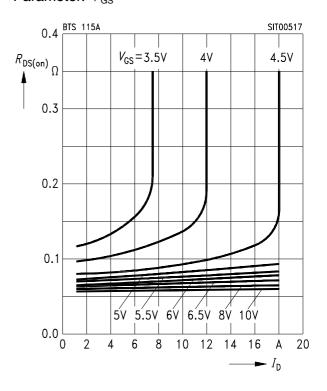


**Typical output characteristics**  $I_{\rm D} = f(V_{\rm DS})$ Parameter:  $t_{\rm p} = 80 \ \mu s$ 

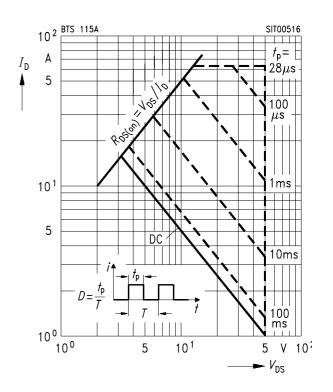


Typ. drain-source on-state resistance  $R_{\text{DS(on)}} = f(I_{\text{D}})$ 

Parameter:  $V_{GS}$ 



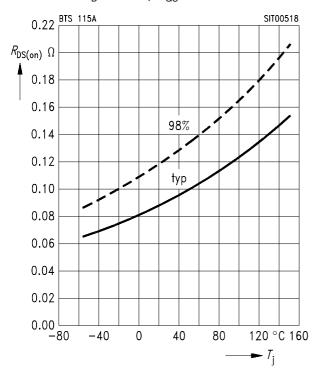
Safe operating area  $I_D = f(V_{DS})$ Parameter: D = 0.01,  $T_C = 25 \text{ °C}$ 



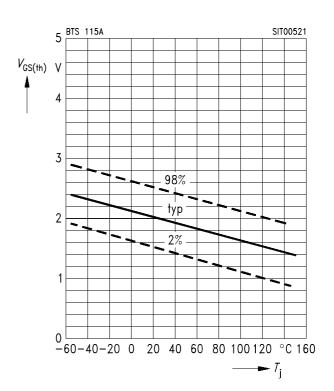


#### Drain-source on-state resistance

 $R_{\text{DS(on)}} = f(T_{\text{j}})$ Parameter:  $I_{\text{D}} = 7.8$  A,  $V_{\text{GS}} = 4.5$  V

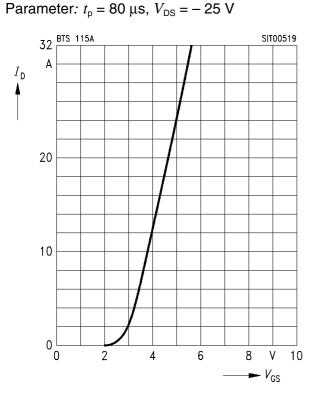


Gate threshold voltage  $V_{GS(th)} = f(T_j)$ Parameter:  $V_{DS} = V_{GS}$ ,  $I_D = -1$  mA

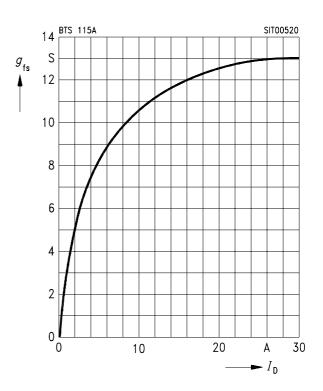


#### Typ. transfer characteristic

 $I_{\rm D} = f(V_{\rm GS})$ 



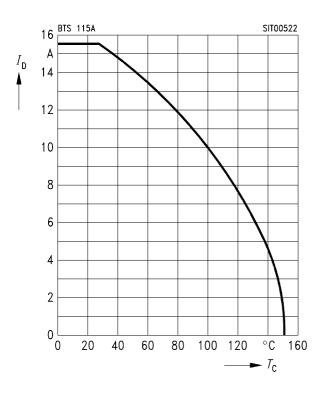
**Typ. transconductance**  $g_{fs} = f(I_D)$ Parameter:  $t_p = 80 \ \mu s$ ,  $V_{DS} = -25 \ V$ 

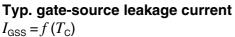




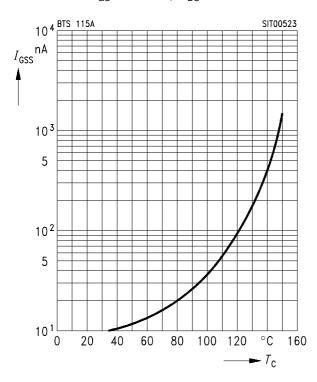
Continuous drain current  $I_{\rm D} = f(T_{\rm C})$ 

Parameter:  $V_{\rm GS} \ge 4.5 \text{ V}$ 



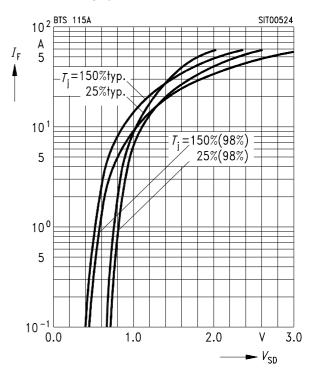


Parameter:  $V_{GS} = -20 \text{ V}, V_{DS} = 0$ 

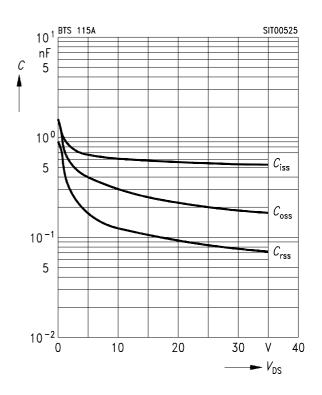


Forward characteristics of reverse diode  $I_{\rm F}$  =  $f\left(V_{\rm SD}\right)$ 

Parameter:  $T_{j}$ ,  $t_{p}$  = 80  $\mu$ s



**Typ. capacitances**  $C = f(V_{DS})$ Parameter:  $V_{GS} = 0, f = 1$  MHz

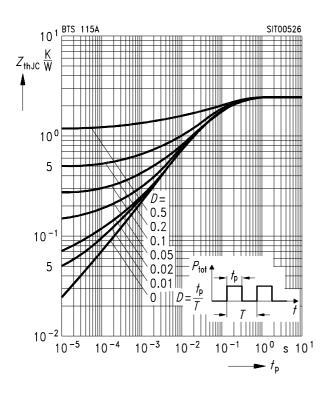




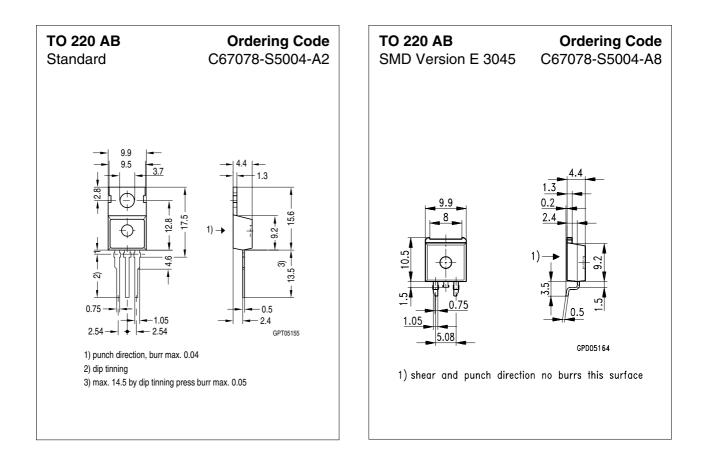


### Transient thermal impedance $Z_{\text{thJC}} = f(t_{\text{p}})$

Parameter:  $D = t_p/T$ 









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